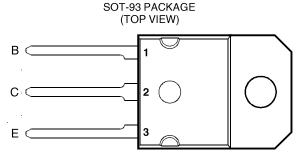


BD246, BD246A, BD246B, BD246C PNP SILICON POWER TRANSISTORS

- Designed for Complementary Use with the BD245 Series
- 80 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- 15 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT	
	BD246		-55	
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD246A	V	-70	v
	BD246B	V _{CER}	-90	v
	BD246C		-115	
	BD246		-45	
Collector-emitter voltage (I _C = -30 mA)	BD246A	V	-60	v
	BD246B	V _{CEO}	-80	V
	BD246C		-100	
Emitter-base voltage			-5	V
Continuous collector current			-10	Α
Peak collector current (see Note 1)			-15	Α
Continuous base current			-3	Α
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)			80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)			3	W
Unclamped inductive load energy (see Note 4)			62.5	mJ
Operating junction temperature range			-65 to +150	,C
Storage temperature range			-65 to +150	,C
Lead temperature 3.2 mm from case for 10 seconds			250	°C

NOTES: 1. This value applies for $t_p \le 0.3$ ms, duty cycle $\le 10\%$.

- 2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.
- 3. Derate linearly to 150°C free air temperature at the rate of 24 mW/°C.
- 4. This rating is based on the capability of the transistor to operate safely in a circuit of: L = 20 mH, $I_{B(on)}$ = -0.4 A, R_{BE} = 100 Ω , $V_{BE(off)}$ = 0, R_{S} = 0.1 Ω , V_{CC} = -20 V.

BD246, BD246A, BD246B, BD246C PNP SILICON POWER TRANSISTORS

electrical characteristics at 25°C case temperature

	PARAMETER		TEST CONDITION	ONS	MIN	TYP	MAX	UNIT
V _{(BR)CEO}	Collector-emitter breakdown voltage	I _C = -30 mA (see Note 5)	I _B = 0	BD246 BD246A BD246B BD246C	-45 -60 -80 -100			V
I _{CES}	Collector-emitter cut-off current	$V_{CE} = -55 \text{ V}$ $V_{CE} = -70 \text{ V}$ $V_{CE} = -90 \text{ V}$ $V_{CE} = -115 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD246 BD246A BD246B BD246C			-0.4 -0.4 -0.4 -0.4	mA
I _{CEO}	Collector cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -60 \text{ V}$	$I_{B} = 0$ $I_{B} = 0$	BD246/246A BD246B/246C			-0.7 -0.7	mA
I _{EBO}	Emitter cut-off current	V _{EB} = -5 V	I _C = 0				-1	mA
h _{FE}	Forward current transfer ratio	$V_{CE} = -4 V$ $V_{CE} = -4 V$ $V_{CE} = -4 V$	$I_C = -1 A$ $I_C = -3 A$ $I_C = -10 A$	(see Notes 5 and 6)	40 20 4			
V _{CE(sat)}	Collector-emitter saturation voltage	$I_B = -0.3 \text{ A}$ $I_B = -2.5 \text{ A}$	I _C = -3 A I _C = -10 A	(see Notes 5 and 6)			-1 -4	٧
V_{BE}	Base-emitter voltage	$V_{CE} = -4 V$ $V_{CE} = -4 V$	$I_C = -3 A$ $I_C = -10 A$	(see Notes 5 and 6)			-1.6 -3	٧
h _{fe}	Small signal forward current transfer ratio	V _{CE} = -10 V	I _C = -0.5 A	f = 1 kHz	20			
h _{fe}	Small signal forward current transfer ratio	V _{CE} = -10 V	I _C = -0.5 A	f = 1 MHz	3	-		

thermal characteristics

PARAMETER			TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			42	°C/W

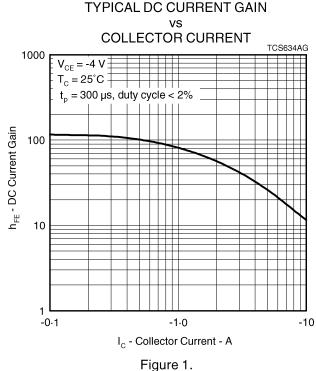
resistive-load-switching characteristics at 25°C case temperature

	PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t _{on}	Turn-on time	I _C = -1 A	$I_{B(on)} = -0.1 A$	$I_{B(off)} = 0.1 A$		0.2		μs
t _{off}	Turn-off time	$V_{BE(off)} = 3.7 V$	$R_L = 20 \Omega$	$t_p = 20 \ \mu s, \ dc \le 2\%$		0.8		μs

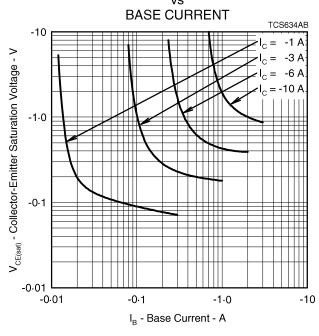
 $[\]begin{tabular}{ll} \dagger Voltage and current values shown are nominal; exact values vary slightly with transistor parameters. \end{tabular}$

<sup>NOTES: 5. These parameters must be measured using pulse techniques, t_p = 300 μs, duty cycle ≤ 2%.
6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.</sup>

TYPICAL CHARACTERISTICS



COLLECTOR-EMITTER SATURATION VOLTAGE



. Figure 2.

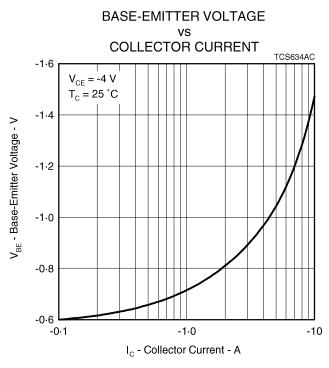
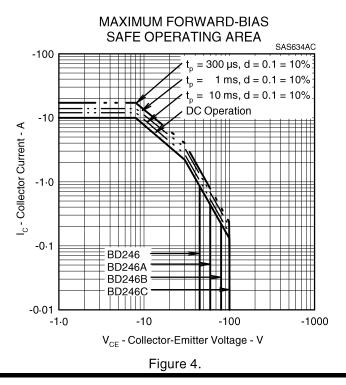


Figure 3.

MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

MAXIMUM POWER DISSIPATION

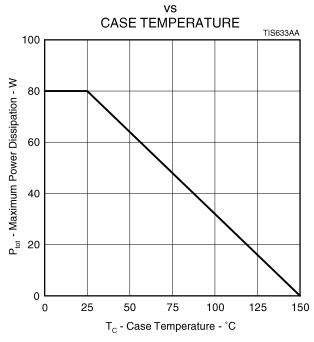


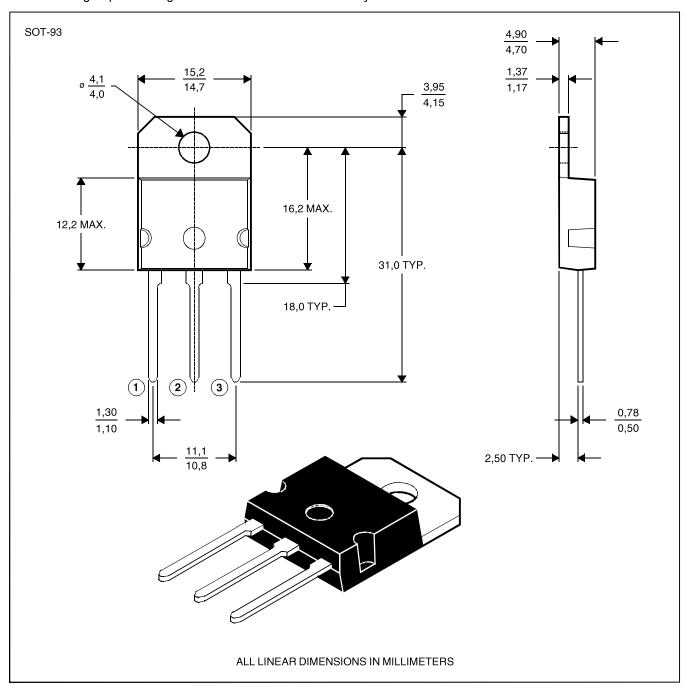
Figure 5.

MECHANICAL DATA

SOT-93

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: The centre pin is in electrical contact with the mounting tab.